

N-CHANNEL SILICON POWER MOSFET

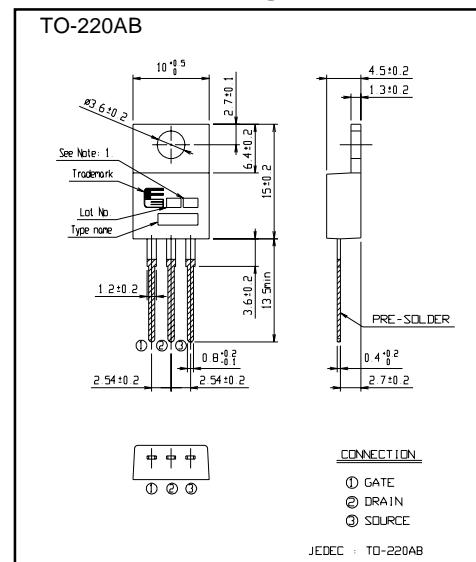
FAP-IIIB SERIES

■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- High voltage
- Avalanche-proof

■ Applications

- Switching regulators
- DC-DC converters
- General purpose power amplifier

■ Outline Drawings**■ Maximum ratings and characteristics****● Absolute maximum ratings (Tc=25°C unless otherwise specified)**

Item	Symbol	Rating	Unit	Remarks
Drain-source voltage	VDS	30	V	
Continuous drain current	Id	±50	A	
Pulsed drain current	Id[puls]	±200	A	
Gate-source peak voltage	VGS	±16	V	
Maximum avalanche energy	EAV	520	mJ	*1
Maximum power dissipation	PD	60	W	
Operating and storage temperature range	Tch	+150	°C	
	Tstg	-55 to +150	°C	

*1 L=0.277mH, Vcc=12V

● Electrical characteristics (Tc =25°C unless otherwise specified)

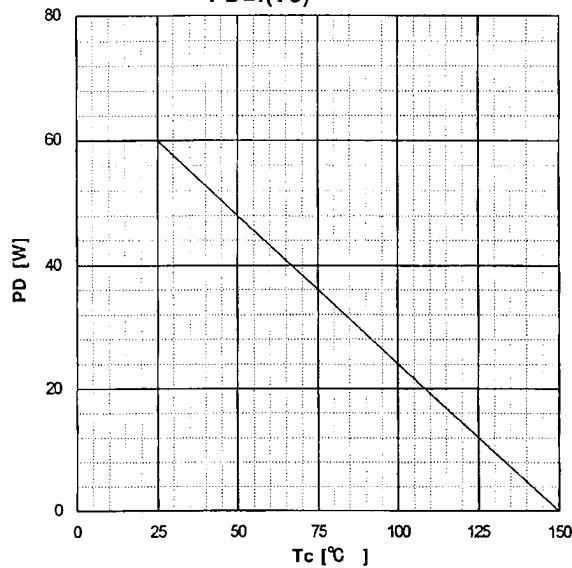
Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	Id=1mA VGS=0V	30			V
Gate threshold voltage	VGS(th)	Id=1mA VDS=VGS	1.0	1.5	2.0	V
Zero gate voltage drain current	IdSS	VDS=30V VGS=0V		10	500	µA
		Tch=25°C		0.2	1.0	mA
Gate-source leakage current	IGSS	VGS=±16V VDS=0V		10	100	nA
Drain-source on-state resistance	RDS(on)	Id=25A VGS=10V	12	17		mΩ
		VGS=4V		7.5	10	mΩ
Forward transconductance	gfs	Id=25A VDS=25V	22	45		S
Input capacitance	Ciss	VDS=25V		2750	4130	
Output capacitance	Coss	VGS=0V		1300	1950	
Reverse transfer capacitance	Crss	f=1MHz		600	900	pF
Turn-on time	td(on)	Vcc=15V RG=10 Ω		13	20	
	tr	Id=50A		55	83	
Turn-off time	td(off)	VGS=10V		180	270	
	tf			150	230	ns
Avalanche capability	Iav	L=100µH Tch=25°C	50			A
Diode forward on-voltage	VSD	If=2xIDR VGS=0V Tch=25°C		1.14	1.71	V
Reverse recovery time	trr	If=2xIDR VGS=0V		85	130	ns
Reverse recovery charge	Qrr	-di/dt=100A/µs Tch=25°C		0.17		µC

● Thermal characteristics

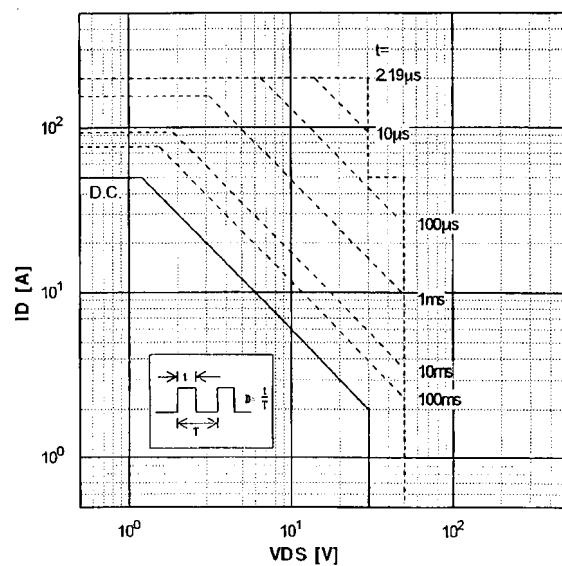
Item	Symbol	Min.	Typ.	Max.	Units
Thermal resistance	Rth(ch-c)			2.08	°C/W
	Rth(ch-a)			75.0	°C/W

■ Characteristics

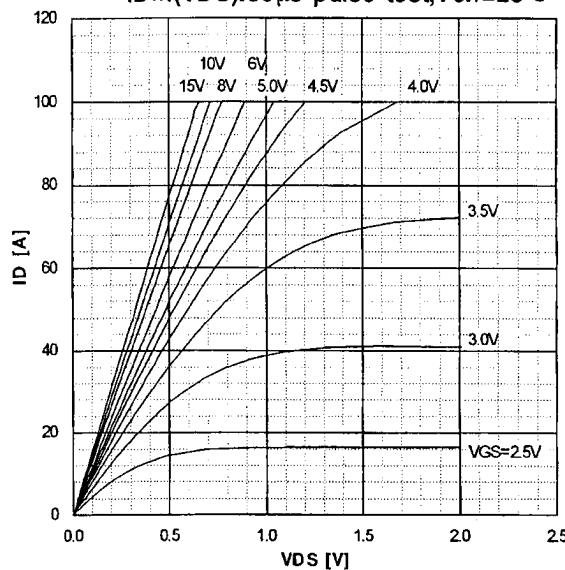
Power Dissipation
 $PD=f(T_c)$



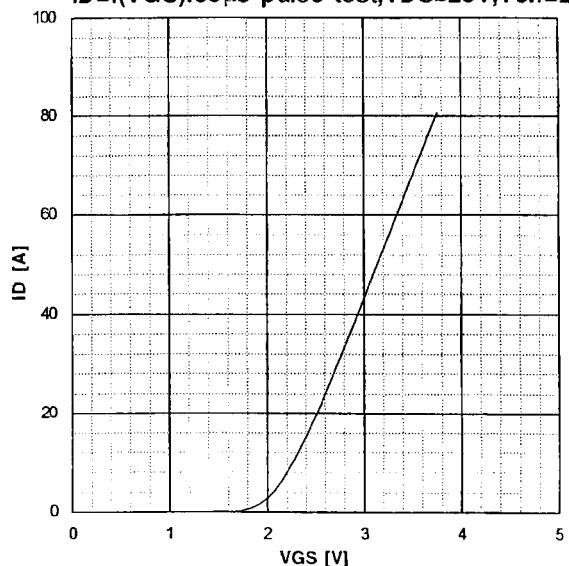
Safe operating area
 $ID=f(VDS):D=0.01,T_c=25^\circ\text{C}$



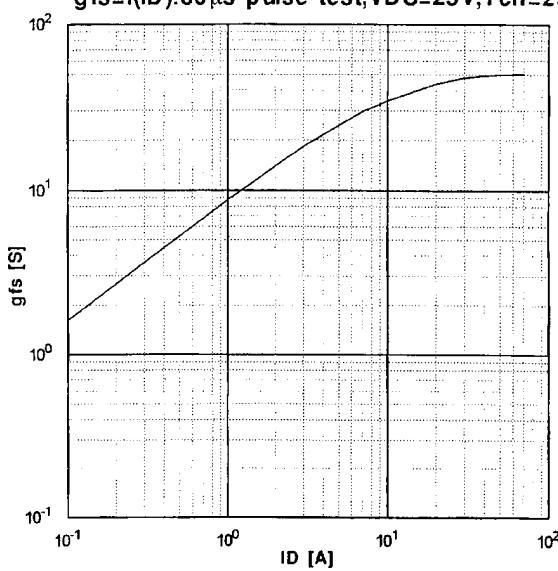
Typical Output Characteristics
 $ID=f(VDS):80\mu\text{s pulse test},T_{ch}=25^\circ\text{C}$



Typical Transfer Characteristic
 $ID=f(VGS):80\mu\text{s pulse test},VDS=25\text{V},T_{ch}=25^\circ\text{C}$



Typical Transconductance
 $g_{fs}=f(ID):80\mu\text{s pulse test},VDS=25\text{V},T_{ch}=25^\circ\text{C}$



Typical Drain-Source on-state Resistance
 $R_{DS(on)}=f(ID):80\mu\text{s pulse test},T_{ch}=25^\circ\text{C}$

